



**ALPHA & OMEGA**  
SEMICONDUCTOR



**AO6801**  
**Dual P-Channel Enhancement Mode Field Effect Transistor**

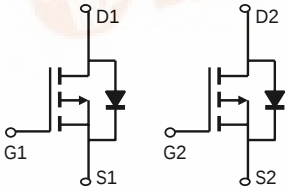
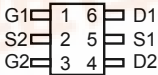
**General Description**

The AO6801 uses advanced trench technology to provide excellent  $R_{DS(ON)}$  and low gate charge. This device is suitable for use as a load switch or in PWM applications. *Standard Product AO6801 is Pb-free (meets ROHS & Sony 259 specifications). AO6801L is a Green Product ordering option. AO6801 and AO6801L are electrically identical.*

**Features**

$V_{DS}$  (V) = -30V  
 $I_D$  = -2.3 A ( $V_{GS}$  = -10V)  
 $R_{DS(ON)}$  < 135m $\Omega$  ( $V_{GS}$  = -10V)  
 $R_{DS(ON)}$  < 185m $\Omega$  ( $V_{GS}$  = -4.5V)  
 $R_{DS(ON)}$  < 265m $\Omega$  ( $V_{GS}$  = -2.5V)

TSOP6  
Top View



**Absolute Maximum Ratings**  $T_A=25^\circ\text{C}$  unless otherwise noted

| Parameter                              | Symbol         | Maximum    | Units            |
|----------------------------------------|----------------|------------|------------------|
| Drain-Source Voltage                   | $V_{DS}$       | -30        | V                |
| Gate-Source Voltage                    | $V_{GS}$       | $\pm 12$   | V                |
| Continuous Drain Current <sup>A</sup>  | $I_D$          | -2.3       | A                |
| $T_A=25^\circ\text{C}$                 |                |            |                  |
| $T_A=70^\circ\text{C}$                 | $I_D$          | -1.8       | A                |
| Pulsed Drain Current <sup>B</sup>      | $I_{DM}$       | -20        |                  |
| Power Dissipation <sup>A</sup>         | $P_D$          | 1.15       | W                |
| $T_A=25^\circ\text{C}$                 |                |            |                  |
| $T_A=70^\circ\text{C}$                 | $P_D$          | 0.73       | W                |
| Junction and Storage Temperature Range | $T_J, T_{STG}$ | -55 to 150 | $^\circ\text{C}$ |

**Thermal Characteristics**

| Parameter                                | Symbol          | Typ | Max | Units              |
|------------------------------------------|-----------------|-----|-----|--------------------|
| Maximum Junction-to-Ambient <sup>A</sup> | $R_{\theta JA}$ | 78  | 110 | $^\circ\text{C/W}$ |
| $t \leq 10\text{s}$                      |                 |     |     |                    |
| Maximum Junction-to-Ambient <sup>A</sup> | $R_{\theta JA}$ | 106 | 150 | $^\circ\text{C/W}$ |
| Steady-State                             |                 |     |     |                    |
| Maximum Junction-to-Lead <sup>C</sup>    | $R_{\theta JL}$ | 64  | 80  | $^\circ\text{C/W}$ |
| Steady-State                             |                 |     |     |                    |



Electrical Characteristics (T<sub>J</sub>=25°C unless otherwise noted)

| Symbol                      | Parameter                             | Conditions                                                                                  | Min  | Typ        | Max        | Units |
|-----------------------------|---------------------------------------|---------------------------------------------------------------------------------------------|------|------------|------------|-------|
| <b>STATIC PARAMETERS</b>    |                                       |                                                                                             |      |            |            |       |
| BV <sub>DSS</sub>           | Drain-Source Breakdown Voltage        | I <sub>D</sub> =-250μA, V <sub>GS</sub> =0V                                                 | -30  |            |            | V     |
| I <sub>DSS</sub>            | Zero Gate Voltage Drain Current       | V <sub>DS</sub> =-24V, V <sub>GS</sub> =0V<br>T <sub>J</sub> =55°C                          |      |            | -1<br>-5   | μA    |
| I <sub>GSS</sub>            | Gate-Body leakage current             | V <sub>DS</sub> =0V, V <sub>GS</sub> =±12V                                                  |      |            | ±100       | nA    |
| V <sub>GS(th)</sub>         | Gate Threshold Voltage                | V <sub>DS</sub> =V <sub>GS</sub> I <sub>D</sub> =-250μA                                     | -0.6 | -1         | -1.4       | V     |
| I <sub>D(ON)</sub>          | On state drain current                | V <sub>GS</sub> =-4.5V, V <sub>DS</sub> =-5V                                                | -20  |            |            | A     |
| R <sub>DS(ON)</sub>         | Static Drain-Source On-Resistance     | V <sub>GS</sub> =-10V, I <sub>D</sub> =-2.3A<br>T <sub>J</sub> =125°C                       |      | 107<br>154 | 135<br>190 | mΩ    |
|                             |                                       | V <sub>GS</sub> =-4.5V, I <sub>D</sub> =-2A                                                 |      | 135        | 185        | mΩ    |
|                             |                                       | V <sub>GS</sub> =-2.5V, I <sub>D</sub> =-1A                                                 |      | 195        | 265        | mΩ    |
| g <sub>FS</sub>             | Forward Transconductance              | V <sub>DS</sub> =-5V, I <sub>D</sub> =-2.3A                                                 |      | 8          |            | S     |
| V <sub>SD</sub>             | Diode Forward Voltage                 | I <sub>S</sub> =-1A, V <sub>GS</sub> =0V                                                    |      | -0.85      | -1         | V     |
| I <sub>S</sub>              | Maximum Body-Diode Continuous Current |                                                                                             |      |            | -1.35      | A     |
| <b>DYNAMIC PARAMETERS</b>   |                                       |                                                                                             |      |            |            |       |
| C <sub>iss</sub>            | Input Capacitance                     | V <sub>GS</sub> =0V, V <sub>DS</sub> =-15V, f=1MHz                                          |      | 409        |            | pF    |
| C <sub>oss</sub>            | Output Capacitance                    |                                                                                             |      | 55         |            | pF    |
| C <sub>rss</sub>            | Reverse Transfer Capacitance          |                                                                                             |      | 42         |            | pF    |
| R <sub>g</sub>              | Gate resistance                       | V <sub>GS</sub> =0V, V <sub>DS</sub> =0V, f=1MHz                                            |      | 12         |            | Ω     |
| <b>SWITCHING PARAMETERS</b> |                                       |                                                                                             |      |            |            |       |
| Q <sub>g</sub>              | Total Gate Charge                     | V <sub>GS</sub> =-4.5V, V <sub>DS</sub> =-15V, I <sub>D</sub> =-2.0A                        |      | 4.9        |            | nC    |
| Q <sub>gs</sub>             | Gate Source Charge                    |                                                                                             |      | 0.6        |            | nC    |
| Q <sub>gd</sub>             | Gate Drain Charge                     |                                                                                             |      | 1.6        |            | nC    |
| t <sub>D(on)</sub>          | Turn-On DelayTime                     | V <sub>GS</sub> =-10V, V <sub>DS</sub> =-15V, R <sub>L</sub> =7.5Ω,<br>R <sub>GEN</sub> =3Ω |      | 6.9        |            | ns    |
| t <sub>r</sub>              | Turn-On Rise Time                     |                                                                                             |      | 3.3        |            | ns    |
| t <sub>D(off)</sub>         | Turn-Off DelayTime                    |                                                                                             |      | 38.5       |            | ns    |
| t <sub>f</sub>              | Turn-Off Fall Time                    |                                                                                             |      | 13.2       |            | ns    |
| t <sub>rr</sub>             | Body Diode Reverse Recovery Time      | I <sub>F</sub> =-2.0A, dI/dt=100A/μs                                                        |      | 15         |            | ns    |
| Q <sub>rr</sub>             | Body Diode Reverse Recovery Charge    | I <sub>F</sub> =-2.0A, dI/dt=100A/μs                                                        |      | 8          |            | nC    |

A: The value of R<sub>θJA</sub> is measured with the device mounted on 1 in<sup>2</sup> FR-4 board with 2oz. Copper, in a still air environment with T<sub>A</sub>=25°C. The value in any given application depends on the user's specific board design. The current rating is based on the t ≤ 10s thermal resistance rating.

B: Repetitive rating, pulse width limited by junction temperature.

C: The R<sub>θJA</sub> is the sum of the thermal impedance from junction to lead R<sub>θJL</sub> and lead to ambient.

D: The static characteristics in Figures 1 to 6,12,14 are obtained using 80μs pulses, duty cycle 0.5% max.

E: These tests are performed with the device mounted on 1 in<sup>2</sup> FR-4 board with 2oz. Copper, in a still air environment with T<sub>A</sub>=25°C. The SOA curve provides a single pulse rating.

Rev 2 : June 2005

THIS PRODUCT HAS BEEN DESIGNED AND QUALIFIED FOR THE CONSUMER MARKET. APPLICATIONS OR USES AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS ARE NOT AUTHORIZED. AOS DOES NOT ASSUME ANY LIABILITY ARISING OUT OF SUCH APPLICATIONS OR USES OF ITS PRODUCTS. AOS RESERVES THE RIGHT TO IMPROVE PRODUCT DESIGN, FUNCTIONS AND RELIABILITY WITHOUT NOTICE.

TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

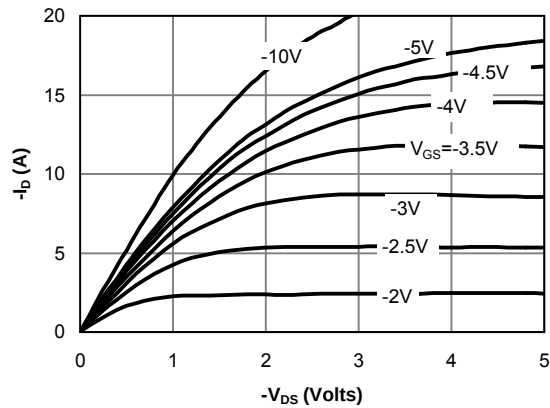


Fig 1: On-Region Characteristics

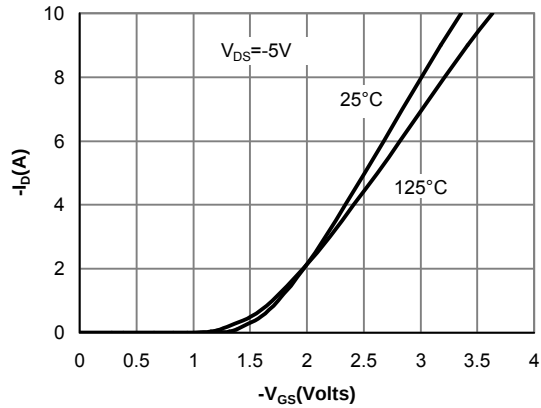


Figure 2: Transfer Characteristics

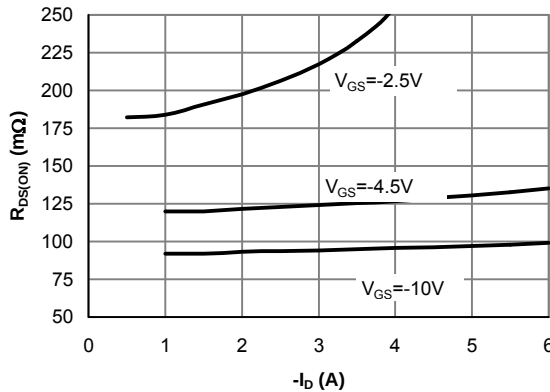


Figure 3: On-Resistance vs. Drain Current and Gate Voltage

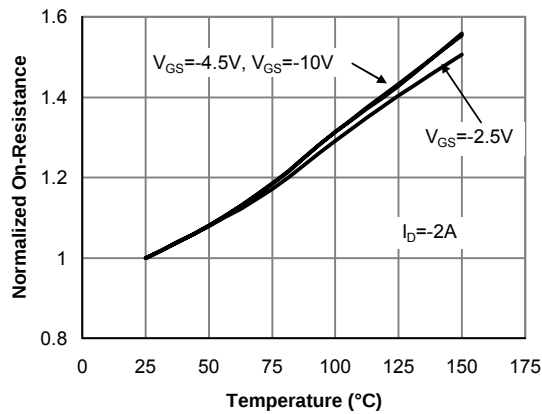


Figure 4: On-Resistance vs. Junction Temperature

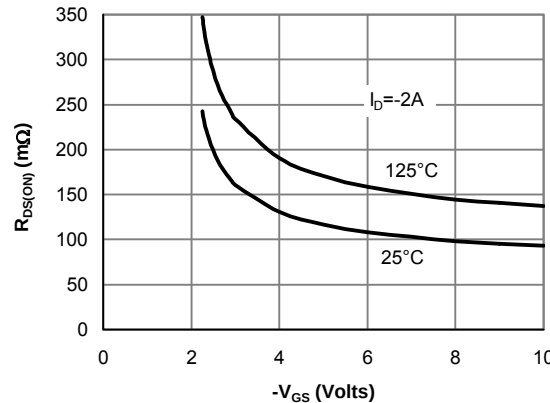


Figure 5: On-Resistance vs. Gate-Source Voltage

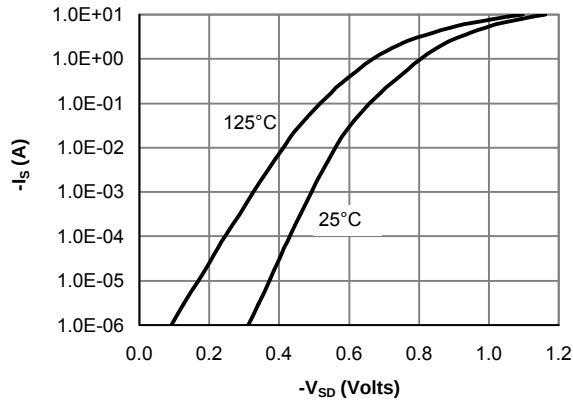


Figure 6: Body-Diode Characteristics

## TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

